



<b>Form Type</b>	Distribute	<b>Version</b>	2.0	<b>Ref</b>	IPC 1752A	<b>Sectionals</b>	Material Info	<b>Subsectionals</b>	D, A
<b>Supplier Information</b>									
<b>Company Name</b>	TE Connectivity	<b>Request Document ID</b>		<b>Contact Name</b>	Benfer, David W	<b>Contact Title</b>	Prod Compliance Engineer, Eng Proc Opt/LEANPD		
<b>Company Unique ID</b>	TE Connectivity	<b>Response Date</b>	2017-03-06	<b>Contact Email</b>	dave.benfer@te.com				
<b>Contact Phone Number</b>	717-986-3725								
<b>Legal Statement</b>									
<b>Supplier Acceptance</b>	true								
<b>Legal Statement</b>									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
<b>Product</b>									
<b>Manufacturer Item number</b>	1827236-4	<b>Amount</b>	4393.824	<b>Version</b>	-	<b>Identity</b>			
<b>Manufacturer Item Name</b>	SEMI-HARD TRAY DDR2 SODIMM SOCKET 200P 4	<b>Weight Uom</b>	mg	<b>Mfr Site</b>		<b>Authority</b>			
<b>Date</b>		<b>UOM</b>	Each						
<b>EUroHS-0508</b>	Product(s) meets EU RoHS requirement without any exemptions								
<b>ChinaRoHS-0508</b>	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
<b>EUREACH-0616</b>	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
<b>Complex Article Description</b>	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed								
<b>Product Disclosure</b>									
<b>Sub-Item/Material/Substance</b>	<b>Level</b>	<b>Name</b>	<b>Substance Category</b>	<b>Substance CAS</b>	<b>Substance Concentration</b>	<b>Quantity</b>	<b>Mass per Unit</b>	<b>UOM</b>	<b>Exemption</b>
Sub-Item	1	HSG DDR2 SODIMM SOCKET 200P 4H STD TYPE				1.0	1460.0	mg	
Material	2	LCP-GF30				1.0	1460.0	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	3.0	1.0	43.8	mg	
Substance	3	Ethene, homopolymer	Supplier	9002-88-4	0.2	1.0	2.92	mg	
Substance	3	Carbon black	Supplier	1333-86-4	2.0	1.0	29.2	mg	
Substance	3	2,6-Naphthalenedi carboxylic acid, polymer with 1,4-benzenedicarb oxylic acid, 1,4-benzenediol, [1,1'-biphenyl]-4,4'-diol and 4-hydroxybenzoi c acid	Supplier	126710-21-2	65.8	1.0	960.68	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	29.0	1.0	423.4	mg	
Sub-Item	1	CONTACT (SEPARATE) FOR DDR SOD				200.0	11.26402	mg	
Material	2	Nickel Plate				200.0	0.35	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	200.0	7.0E-4	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	200.0	3.5E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	200.0	0.34895	mg	
Material	2	Copper Alloy				200.0	10.9	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	200.0	0.0109	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.02	200.0	0.00218	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	200.0	0.00109	mg	

Substance	3	Iron	Supplier	7439-89-6	0.2	200.0	0.0218	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.0010	200.0	1.09E-4	mg	
Substance	3	Tin	Supplier	7440-31-5	1.5	200.0	0.1635	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	200.0	0.00109	mg	
Substance	3	Phosphorus	Supplier	7723-14-0	0.1	200.0	0.0109	mg	
Substance	3	Copper	Supplier	7440-50-8	76.0475	200.0	8.28918	mg	
Substance	3	Zinc	Supplier	7440-66-6	21.73	200.0	2.36857	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	200.0	1.09E-4	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	200.0	5.45E-5	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	200.0	0.00763	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.2	200.0	0.0218	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.01	200.0	0.00109	mg	
Material	2	Gold Plate				200.0	0.01402	mg	
Substance	3	Gold	Supplier	7440-57-5	99.7	200.0	0.01397794	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.3	200.0	4.206E-5	mg	
Sub-Item	1	LATCH RIGHT FOR DDR2 SODIMM SOCKET 4H DI				1.0	340.51	mg	
Material	2	Stainless Steel				1.0	328.0	mg	
Substance	3	Chromium	Supplier	7440-47-3	18.0	1.0	59.04	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.5	1.0	1.64	mg	
Substance	3	Phosphorus	Supplier	7723-14-0	0.045	1.0	0.1476	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.0	0.0328	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.01	1.0	0.0328	mg	
Substance	3	Silicon	Supplier	7440-21-3	1.5	1.0	4.92	mg	
Substance	3	Carbon	Supplier	7440-44-0	0.15	1.0	0.492	mg	
Substance	3	Manganese	Supplier	7439-96-5	2.0	1.0	6.56	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.03	1.0	0.0984	mg	
Substance	3	Sulfur	Supplier	7704-34-9	0.03	1.0	0.0984	mg	
Substance	3	Iron	Supplier	7439-89-6	68.6147	1.0	225.05622	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.0999	1.0	0.32767	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0099	1.0	0.032472	mg	
Substance	3	Nickel	Nickel	7440-02-0	9.0	1.0	29.52	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.0	0.00164	mg	
Material	2	Tin Plate				1.0	9.52	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.01904	mg	
Substance	3	Tin	Supplier	7440-31-5	99.73	1.0	9.4943	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	1.0	0.006664	mg	
Material	2	Nickel Plate				1.0	2.99	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.00598	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.00299	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	1.0	2.98103	mg	
Sub-Item	1	LATCH LEFT FOR DDR2 SODIMM SOCKET 4H DIR				1.0	340.51	mg	
Material	2	Stainless Steel				1.0	328.0	mg	
Substance	3	Chromium	Supplier	7440-47-3	18.0	1.0	59.04	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.5	1.0	1.64	mg	
Substance	3	Phosphorus	Supplier	7723-14-0	0.045	1.0	0.1476	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.0	0.0328	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.01	1.0	0.0328	mg	
Substance	3	Silicon	Supplier	7440-21-3	1.5	1.0	4.92	mg	
Substance	3	Carbon	Supplier	7440-44-0	0.15	1.0	0.492	mg	
Substance	3	Manganese	Supplier	7439-96-5	2.0	1.0	6.56	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.03	1.0	0.0984	mg	
Substance	3	Sulfur	Supplier	7704-34-9	0.03	1.0	0.0984	mg	

Substance	3	Iron	Supplier	7439-89-6	68.6147	1.0	225.05622	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.0999	1.0	0.32767	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0099	1.0	0.032472	mg	
Substance	3	Nickel	Nickel	7440-02-0	9.0	1.0	29.52	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.0	0.00164	mg	
Material	2	Tin Plate				1.0	9.52	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.01904	mg	
Substance	3	Tin	Supplier	7440-31-5	99.73	1.0	9.4943	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	1.0	0.006664	mg	
Material	2	Nickel Plate				1.0	2.99	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.00598	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.00299	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	1.0	2.98103	mg	